



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Attorney Docket No. 035532/0118**

Applicant: Akira CHINDA et al.  
Title: WIRING BOARD, SEMICONDUCTOR DEVICE, AND  
PROCESS FOR PRODUCTION OF WIRING BOARD  
Serial No.: 10/021,257  
Filed: December 19, 2001  
Examiner: Chambliss, Alonzo  
Art Unit: 2827

**AMENDMENT AND REPLY UNDER 37 C.F.R. § 1.111**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

This communication is responsive to the Office Action dated November 26, 2002, concerning the above-referenced patent application.

Applicant has enclosed with this amendment a Petition for Extension of Time to make this response timely.

Please amend the application as follows:

**IN THE SPECIFICATION:**

Please amend the specification as follows:

Please replace the existing title with --WIRING BOARD UTILIZING A CONDUCTIVE MEMBER HAVING A REDUCED THICKNESS--.